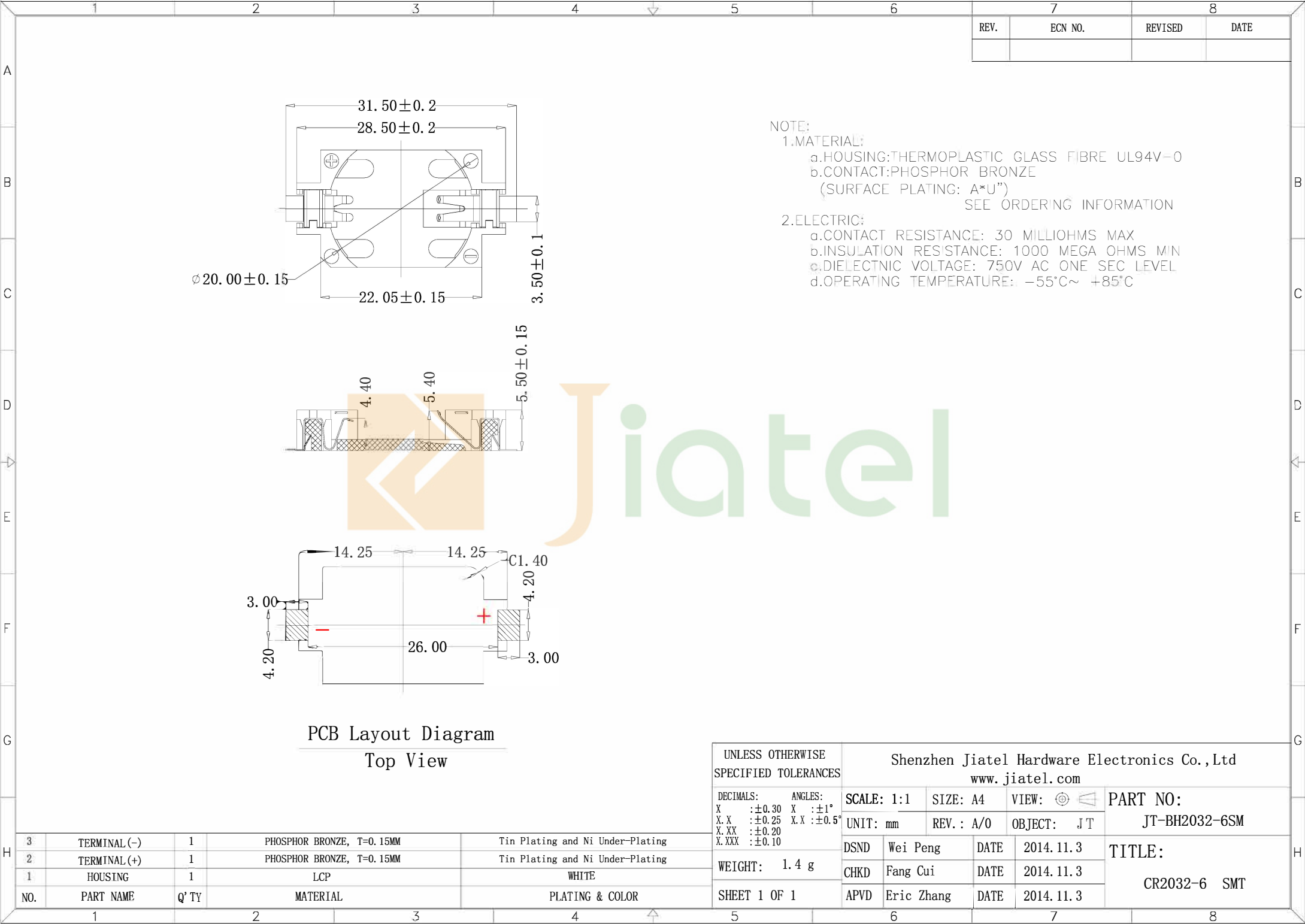




7		8	
REV.	ECN NO.	REVISED	DATE

NOTE:
1.MATERIAL:
a.HOUSING:THERMOPLASTIC GLASS FIBRE UL94V-0
b.CONTACT:PHOSPHOR BRONZE
(SURFACE PLATING: A*U")
SEE ORDERING INFORMATION
2.ELECTRIC:
a.CONTACT RESISTANCE: 30 MILLIOHMS MAX
b.INSULATION RESISTANCE: 1000 MEGA OHMS MIN
c.DIELECTNIC VOLTAGE: 750V AC ONE SEC LEVEL
d.OPERATING TEMPERATURE: -55°C~ +85°C

PCB Layout Diagram
Top View

3	TERMINAL (-)	1	PHOSPHOR BRONZE, T=0.15MM	Tin Plating and Ni Under-Plating
2	TERMINAL (+)	1	PHOSPHOR BRONZE, T=0.15MM	Tin Plating and Ni Under-Plating
1	HOUSING	1	LCP	WHITE
NO.	PART NAME	Q' TY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES		Shenzhen Jiatel Hardware Electronics Co.,Ltd www.jiatel.com			
DECIMALS: X :±0.30 X.X :±0.25 X.XX :±0.20 X.XXX :±0.10	ANGLES: X :±1° X.X :±0.5°	SCALE: 1:1	SIZE: A4	VIEW:	PART NO: JT-BH2032-6SM
WEIGHT: 1.4 g		UNIT: mm	REV.: A/0	OBJECT: JT	TITLE: CR2032-6 SMT
SHEET 1 OF 1		DSND	Wei Peng	DATE	
		CHKD	Fang Cui	DATE	
		APVD	Eric Zhang	DATE	